

Practitioner's Docket No. 1001-133

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Czaplicki et al.

Application No.: 10/783,326

Group No.: 1712

Filed: 02/20/2004

Examiner: Robert E. Sellers

For: EPOXY/ELASTOMER ADDUCT, METHOD OF FORMING SAME AND MATERIALS AND ARTICLES FORMED THEREWITH

**Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Applicants submit this statement in accordance with their duty of disclosure under 37 CFR 1.56 and 1.97-1.98. The submission made herewith is in no way intended as an admission that the cited items constitute material prior art or otherwise would render the claims unpatentable in any way. The submission also is in no way intended to substitute for the Examiner's own independent investigation.

Copies of foreign patent documents and non-patent literature together with a listing on forms PTO/SB/08A & PTO/SB/08B are submitted herewith. Copies of cited U.S. patents and U.S. patent application publications have not been submitted due to the waiver of the requirement under 37 CFR 1.98 (a)(2)(i). Applicants respectfully solicit the Examiner's consideration of the cited references and entry thereof into the record of this application.

This Information Disclosure Statement is being submitted after the mailing of a first Office Action or Notice of Allowance. The fee of \$180.00 is enclosed in the form of a check. If any additional fee is due with the filing of this paper please charge the amount to deposit account 50-1097.

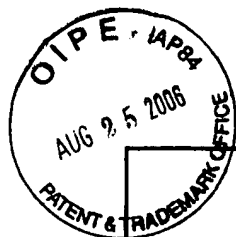
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# **INFORMATION DISCLOSURE STATEMENT BY THE APPLICANT**

Serial No.:	10/783,326
Filing Date:	2/20/2004
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Attorney Docket Number:	1001.133

Examiner's Signature		Date Considered	
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